

## 1.6X0.8mm SMD CHIP LED LAMP (0.25mm Height)

PRELIMINARY SPEC

Part Number: KPG-1608SURKC-T

Hyper Red

#### **Features**

- 1.6mmX0.8mm SMT LED, 0.25mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

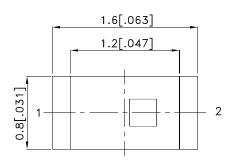
### Description

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

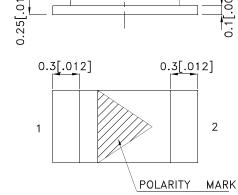
## **Applications**

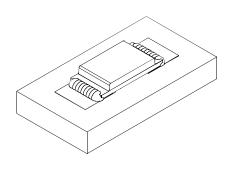
- 1. Mobile phone Keypad indicator and backlight.
- 2.Flat backlight for LCD, switch and symbol.
- 3.Toys.

## **Package Dimensions**









- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1 (0.004")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAI7025 **REV NO: V.2 DATE: MAR/19/2009** PAGE: 1 OF 5 **CHECKED: Allen Liu** APPROVED: WYNEC DRAWN: S.P.Chen ERP: 1203008082

## **Selection Guide**

| Part No.        | Dice                | lv (mcd) [2] Dice Lens Type @ 20mA |      | ,    | Viewing<br>Angle [1] |
|-----------------|---------------------|------------------------------------|------|------|----------------------|
|                 |                     | -                                  | Min. | Тур. | 2θ1/2                |
| KPG-1608SURKC-T | Hyper Red (AlGaInP) | WATER CLEAR                        | 180  | 320  | 120°                 |

#### Notes:

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

# Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter                | Device    | Тур. | Max. | Units | Test Conditions    |
|--------|--------------------------|-----------|------|------|-------|--------------------|
| λpeak  | Peak Wavelength          | Hyper Red | 650  |      | nm    | IF=20mA            |
| λD [1] | Dominant Wavelength      | Hyper Red | 630  |      | nm    | IF=20mA            |
| Δλ1/2  | Spectral Line Half-width | Hyper Red | 20   |      | nm    | IF=20mA            |
| С      | Capacitance              | Hyper Red | 35   |      | pF    | VF=0V;f=1MHz       |
| VF [2] | Forward Voltage          | Hyper Red | 2    | 2.5  | V     | IF=20mA            |
| lR     | Reverse Current          | Hyper Red |      | 10   | uA    | V <sub>R</sub> =5V |

## Notes:

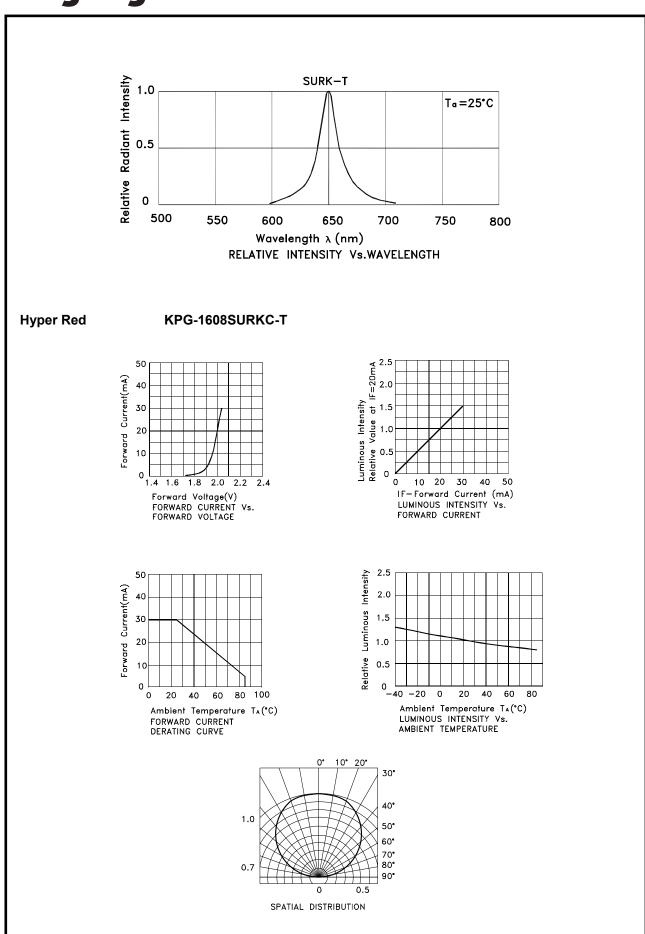
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

#### Absolute Maximum Ratings at TA=25°C

| Autobiato maximum raumgo at 171 20 0 |  |  |  |  |  |
|--------------------------------------|--|--|--|--|--|
| Hyper Red                            | Units                                  |  |  |  |  |
| 75                                   | mW                                     |  |  |  |  |
| 30                                   | mA                                     |  |  |  |  |
| 150                                  | mA                                     |  |  |  |  |
| 5                                    | V                                      |  |  |  |  |
| -40°C To +85°C                       |  |  |  |  |  |
| -40°C To +85°C                       |  |  |  |  |  |
|                                      | 75<br>30<br>150<br>5<br>-40°C To +85°C |  |  |  |  |

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAI7025 **REV NO: V.2** DATE: MAR/19/2009 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: S.P.Chen ERP: 1203008082



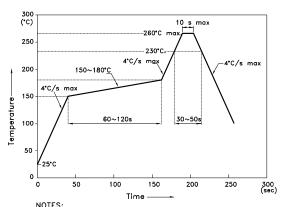
 SPEC NO: DSAI7025
 REV NO: V.2
 DATE: MAR/19/2009
 PAGE: 3 OF 5

 APPROVED: WYNEC
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### KPG-1608SURKC-T

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



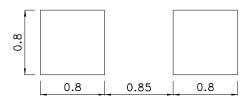
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

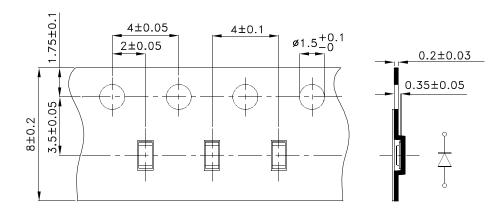
  3.Number of reflow process shall be 2 times or less.

**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

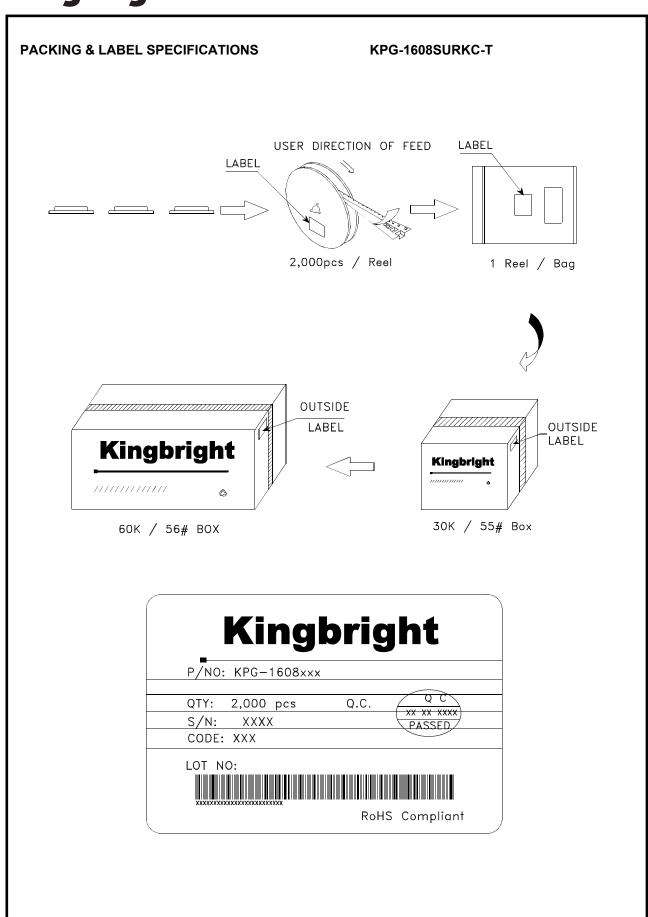


**Tape Dimensions** (Units: mm)

TAPE



SPEC NO: DSAI7025 **REV NO: V.2 DATE: MAR/19/2009** PAGE: 4 OF 5 **APPROVED: WYNEC CHECKED: Allen Liu** DRAWN: S.P.Chen ERP: 1203008082



SPEC NO: DSAI7025 APPROVED: WYNEC REV NO: V.2 CHECKED: Allen Liu DATE: MAR/19/2009 DRAWN: S.P.Chen PAGE: 5 OF 5 ERP: 1203008082